

ESD5651N

Bidirectional ESD protection Diode with normal capacitance

General Description

The ESD5651N is designed to protect voltage sensitive components from damage or latch-up due to ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD for board level. Because of its small size and bi-directional design, it is ideal for use in cellular phones, and portable applications that require audio line protection.

Specification Features

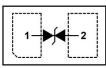
- Miniaturized packaging size suitable for high-density applications: nom 0.039" x 0.024" (1.0x0.6mm)
- Standard Capacitance 100 pF
- Low Clamping Voltage: V_C=12V@I_{PP}=40A
- Reverse Working (Stand-off) Voltage: 4.5V
- Low Leakage current
- Response Time is Typically < 1 ns

Application

- Smartphones, tablet computers
- Blu-ray and DVD recorders and players
- Video equipment and accessories

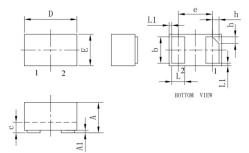






DFN1006-2L

Schematic Diagram



DFN1006-2L

	М	illimete	ers	Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	
Α	0.45	0.50	0.55	0.018	0.020	0.022	
A1	0.00	0.02	0.05	0.000	0.001	0.002	
b	0.45	0.50	0.55	0.018	0.020	0.022	
С	0.12	0.15	0.18	0.005	0.006	0.007	
D	0.95	1.00	1.05	0.037	0.039	0.041	
е	0.59BSC			0.026BSC			
Е	0.55	0.60	0.65	0.022	0.024	0.026	
L	0.25	0.30	0.35	0.010	0.012	0.013	
L1	0.05REF			0.002REF			
h	0.07	0.12	0.17	0.003	0.005	0.007	

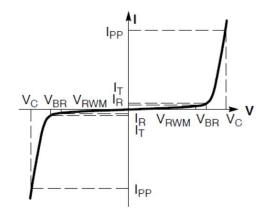
Absolute Maximum Rating

Rating	Symbol	Value	Unit	
Peak pulse power (tp = 8/20µs)	P _{PK}	480	W	
ESD according to IEC61000-4-2 air discharge		±30		
ESD according to IEC61000-4-2 contact discharge	V _{ESD}	±30	kV	
Operating Temperature Range	TJ	-55~+150	$^{\circ}$ C	
Storage temperature	T _{STG}	-55~+150	$^{\circ}$	

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ESD5651N Characteristics(T」=25℃ unless otherwise specified)

Symbol	Parameter
I _{PP}	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
V_{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
I _T	Test Current
V_{BR}	Breakdown Voltage @ I _T
P _{PK}	Peak Power Dissipation
С	Max. Capacitance @ $V_R = 0$ and freq.=1 MHz



Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Reverse Stand-off Voltage	V_{RWM}				4.5	V
Reverse Breakdown Voltage	V_{BR}	I _T =1mA	4.8	5.1	6	V
Reverse Leakage Current	I_R	V _{RWM} =±4.5V			200	nA
Clamping Voltage	Vc	I _{PP} =1.0A ,tp=8/20us			6.5	V
Clamping Voltage	Vc	I _{PP} =40.0A ,tp=8/20us			12	V
Junction Capacitance	CJ	V _R =0V, f =1MHz			100	pF